



**CHENMKO ENTERPRISE CO.,LTD**

**CHT2302WPT**

**SURFACE MOUNT**

**N-Channel Enhancement Mode Field Effect Transistor**

VOLTAGE 20 Volts CURRENT 2.8 Ampere

Lead free devices

**APPLICATION**

- \* Servo motor control.
- \* Power MOSFET gate drivers.
- \* Other switching applications.

**FEATURE**

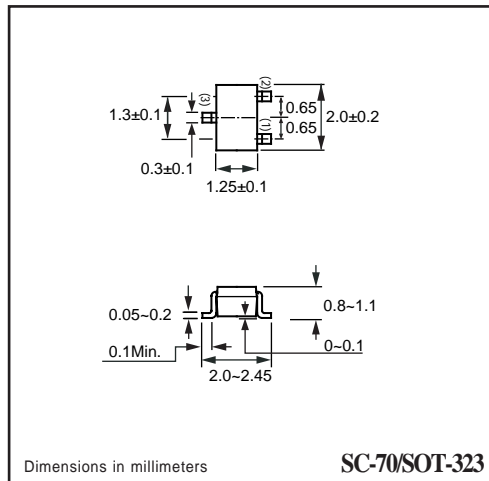
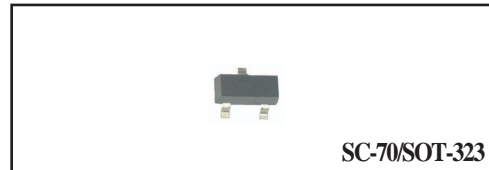
- \* Small surface mounting type. (SC-70/SOT-323)
- \* High density cell design for low  $R_{DS(ON)}$ .
- \* Suitable for high packing density.
- \* Rugged and reliable.
- \* High saturation current capability.
- \* Voltage controlled small signal switch.

**CONSTRUCTION**

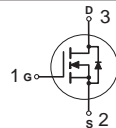
- \* N-Channel Enhancement

**MARKING**

\* 22



**CIRCUIT**



**Absolute Maximum Ratings**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	CHT2302WPT	Units
$V_{DSS}$	Drain-Source Voltage	20	V
$V_{GSS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Maximum Drain Current - Continuous (Note 1)	2.8	A
	- Pulsed (Note 2)	10	
$I_S$	Drain-Source Diode Forward Current (Note 1)	1.6	A
$P_D$	Maximum Power Dissipation (Note 1)	1250	mW
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

Note : 1. Surface Mounted on FR4 Board ,  $t \leq 10\text{sec}$   
 2. Pulse Test , Pulse width  $\leq 300\mu\text{s}$  , Duty Cycle  $\leq 2\%$

**Thermal characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	85	$^\circ\text{C/W}$
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## RATING CHARACTERISTIC CURVES ( CHT2302WPT )

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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### OFF CHARACTERISTICS

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	20			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 16\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage	$V_{GS} = 8\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
$I_{GSS}$	Gate-Body Leakage	$V_{GS} = -8\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

### ON CHARACTERISTICS (Note 2)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	0.7			V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=4.5\text{V}, I_D=3.6\text{A}$			85	m $\Omega$
		$V_{GS}=2.5\text{V}, I_D=3.1\text{A}$			115	
$V_{SD}$	Diode Forward Voltage	$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$			1.0	V

### SWITCHING CHARACTERISTICS (Note 3)

$Q_g$	Total Gate Charge	$V_{DS}=10\text{V}, I_D=1\text{A}$ $V_{GS}=4.5\text{V}$		6.52		nC
$Q_{gs}$	Gate-Source Charge			1.6		
$Q_{gd}$	Gate-Drain Charge			1.16		
$t_{on}$	Turn-On Time	$V_{DD}= 10\text{V}$ $I_D = 1.0\text{A}, V_{GEN} = 4.5\text{ V}$		12		nS
$t_r$	Rise Time			36		
$t_{off}$	Turn-Off Time	$R_L = 10\ \Omega, R_{GEN} = 10\ \Omega$		34		
$t_f$	Fall Time			10		

Note : 3. Guaranteed by design , not subject to production testing

# RATING CHARACTERISTIC CURVES ( CHT2302WPT )

## Typical Electrical Characteristics

Figure 1. Output Characteristics

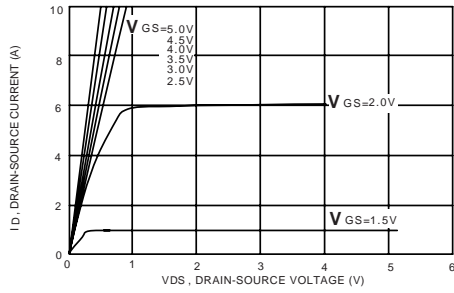


Figure 2. Transfer Characteristics

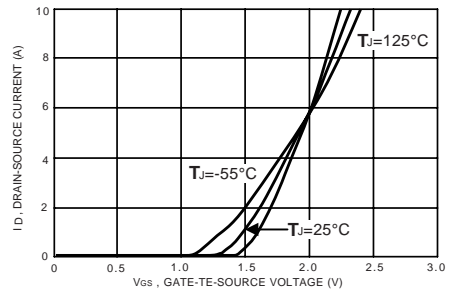


Figure 3. Breakdown Voltage Variation with Temperature

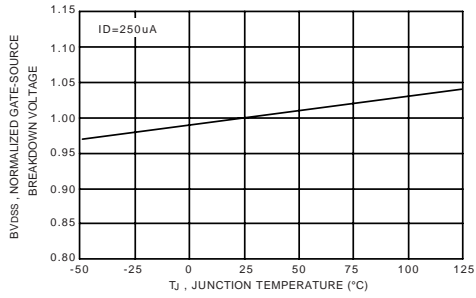


Figure 4. On-Resistance Variation with Temperature

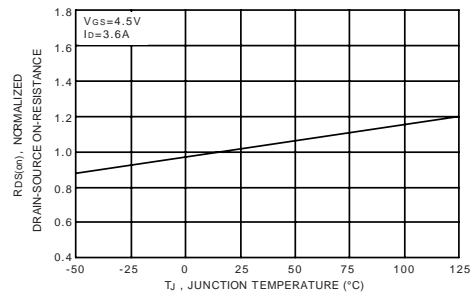


Figure 5. Gate Threshold Variation with Temperature

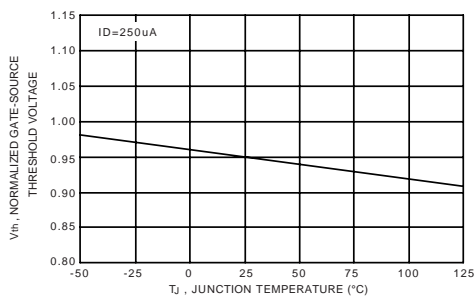


Figure 6. Gate Charge

